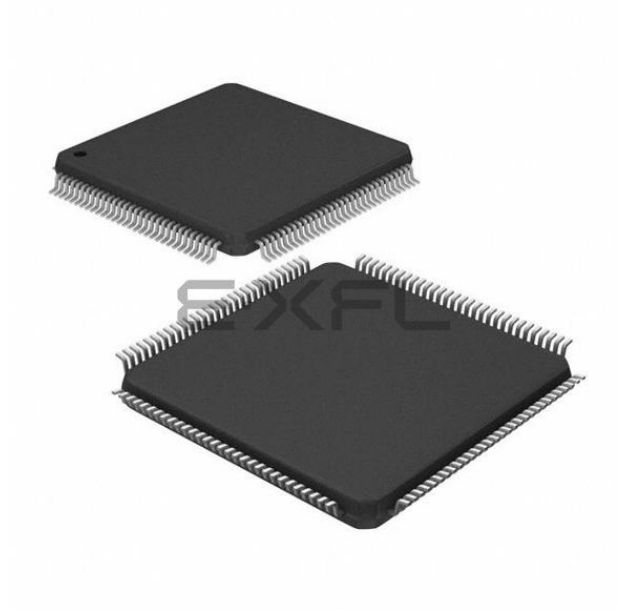
Infineon Technologies - MB90F922NCPMC-GSE1 Datasheet



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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	F²MC-16LX
Core Size	16-Bit
Speed	32MHz
Connectivity	CANbus, LINbus, UART/USART
Peripherals	LCD, LVD, POR, PWM, WDT
Number of I/O	91
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	10K x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 5.5V
Data Converters	A/D 8x8/10b
Oscillator Type	External
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	120-LQFP
Supplier Device Package	120-LQFP (16x16)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb90f922ncpmc-gse1

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- 16-bit reload timer (4 channels)
  16-bit reload timer operation (select toggle output or one-shot output)
  Selectable event count function
- Real time watch timer (main clock)
  Operates directly from oscillator clock.
  Interrupt can be generated by second/minute/hour/date counter overflow.
- PPG timer (6 channels)
  Output pins (3 channels), external trigger input pin (1 channel)
  Operation clock frequencies : f_{CP}, $f_{CP}/2^2$, $f_{CP}/2^4$, $f_{CP}/2^6$
- Delay interrupt
  Generates interrupt for task switching.
  Interrupts to CPU can be generated/cleared by software setting.
- External interrupts (8 channels)
  8-channel independent operation
  Interrupt source setting available : “L” to “H” edge/ “H” to “L” edge/ “L” level/ “H” level.
- 8/10-bit A/D converter (8 channels)
  Conversion time : 3 µs (at f_{CP} = 32 MHz)
  External trigger activation available (P50/INT0/ADTG)
  Internal timer activation available (16-bit reload timer 1)
- UART(LIN/SCI) (4 channels)
  Equipped with full duplex double buffer
  Clock-asynchronous or clock-synchronous serial transfer is available
- CAN interface (4 channels : CAN0 and CAN2, and CAN1 and CAN3 share transmission and reception pins, and interrupt control registers).
  Conforms to CAN specifications version 2.0 Part A and B.
  Automatic resend in case of error.
  Automatic transfer in response to remote frame.
  16 prioritized message buffers for data and ID
  Multiple message support
  Flexible configuration for receive filter : Full bit compare/full bit mask/two partial bit masks
  Supports up to 1 Mbps
  CAN wakeup function (RX connected to INT0 internally)
- LCD controller/driver (32 segment x 4 common)
  Segment driver and command driver with direct LCD panel (display) drive capability
- Reset on detection of low voltage/program loop
  Automatic reset when low voltage is detected
  Program looping detection function
- Stepping motor controller (4 channels)
  High current output for each channel × 4
  Synchronized 8/10-bit PWM for each channel × 2
- Sound generator (2 channels)
  8-bit PWM signal mixed with tone frequency from 8-bit reload counter.
  PWM frequencies : 125 kHz, 62.5 kHz, 31.2 kHz, 15.6 kHz (at f_{CP} = 32 MHz)
  Tone frequencies : PWM frequency /2/ , divided by (reload frequency +1)
- Input/output ports
  General-purpose input/output port (CMOS output) 93 ports
- Function for port input level selection
  Automotive/CMOS-Schmitt
- Flash memory security function
  Protects the contents of Flash memory (Flash memory product only)

■ PIN DESCRIPTIONS

Pin no.	Pin name	I/O circuit type*1	Function
108	X0	A	High-speed oscillation input pin
107	X1		High-speed oscillation output pin
13	X0A	B	Low-speed oscillation input pin
	P92	I	General-purpose I/O port
14	X1A	B	Low-speed oscillation output pin
	P93	I	General-purpose I/O port
90	$\overline{\text{RST}}$	C	Reset input pin
93	P00	F	General-purpose I/O port
	SEG24		LCD controller/driver segment output pin
94	P01	F	General-purpose I/O port
	SEG25		LCD controller/driver segment output pin
95	P02	F	General-purpose I/O port
	SEG26		LCD controller/driver segment output pin
96	P03	F	General-purpose I/O port
	SEG27		LCD controller/driver segment output pin
97	P04	F	General-purpose I/O port
	SEG28		LCD controller/driver segment output pin
98	P05	F	General-purpose I/O port
	SEG29		LCD controller/driver segment output pin
99	P06	F	General-purpose I/O port
	SEG30		LCD controller/driver segment output pin
100	P07	F	General-purpose I/O port
	SEG31		LCD controller/driver segment output pin
101	P10	I	General-purpose I/O port
	PPG2		16-bit PPG ch.2 output pin
	IN5		Input capture ch.5 trigger input pin
102	P11	I	General-purpose I/O port
	TOT0		16-bit reload timer ch.0 TOT output pin
	PPG3		16-bit PPG ch.3 output pin
	IN4		Input capture ch.4 trigger input pin
103	P12	I	General-purpose I/O port
	TIN0		16-bit reload timer ch.0 TIN input pin
	PPG4		16-bit PPG ch.4 output pin

(Continued)

Pin no.	Pin name	I/O circuit type*1	Function
104	P13	I	General-purpose I/O port
	PPG5		16-bit PPG ch.5 output pin
109	P14	I	General-purpose I/O port
	TIN2		16-bit reload timer ch.2 TIN input pin
	IN1		Input capture ch.1 trigger input pin
110	P15	I	General-purpose I/O port
	IN0		Input capture ch.0 trigger input pin
111	COM0	P	LCD controller/driver common output pin
112	COM1	P	LCD controller/driver common output pin
113	COM2	P	LCD controller/driver common output pin
114	COM3	P	LCD controller/driver common output pin
115	P22	F	General-purpose I/O port
	SEG00		LCD controller/driver segment output pin
116	P23	F	General-purpose I/O port
	SEG01		LCD controller/driver segment output pin
117	P24	F	General-purpose I/O port
	SEG02		LCD controller/driver segment output pin
118	P25	F	General-purpose I/O port
	SEG03		LCD controller/driver segment output pin
119	P26	F	General-purpose I/O port
	SEG04		LCD controller/driver segment output pin
120	P27	F	General-purpose I/O port
	SEG05		LCD controller/driver segment output pin
1	P30	F	General-purpose I/O port
	SEG06		LCD controller/driver segment output pin
2	P31	F	General-purpose I/O port
	SEG07		LCD controller/driver segment output pin
3	P32	F	General-purpose I/O port
	SEG08		LCD controller/driver segment output pin
4	P33	F	General-purpose I/O port
	SEG09		LCD controller/driver segment output pin
5	P34	F	General-purpose I/O port
	SEG10		LCD controller/driver segment output pin
6	P35	F	General-purpose I/O port
	SEG11		LCD controller/driver segment output pin

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Pin no.	Pin name	I/O circuit type*1	Function
70	P73	L	General-purpose output-only port
	PWM2M0		Stepping motor controller ch.0 output pin
71	P74	L	General-purpose output-only port
	PWM1P1		Stepping motor controller ch.1 output pin
72	P75	L	General-purpose output-only port
	PWM1M1		Stepping motor controller ch.1 output pin
73	P76	L	General-purpose output-only port
	PWM2P1		Stepping motor controller ch.1 output pin
74	P77	L	General-purpose output-only port
	PWM2M1		Stepping motor controller ch.1 output pin
77	P80	L	General-purpose output-only port
	PWM1P2		Stepping motor controller ch.2 output pin
78	P81	L	General-purpose output-only port
	PWM1M2		Stepping motor controller ch.2 output pin
79	P82	L	General-purpose output-only port
	PWM2P2		Stepping motor controller ch.2 output pin
80	P83	L	General-purpose output-only port
	PWM2M2		Stepping motor controller ch.2 output pin
81	P84	L	General-purpose output-only port
	PWM1P3		Stepping motor controller ch.3 output pin
82	P85	L	General-purpose output-only port
	PWM1M3		Stepping motor controller ch.3 output pin
83	P86	L	General-purpose output-only port
	PWM2P3		Stepping motor controller ch.3 output pin
84	P87	L	General-purpose output-only port
	PWM2M3		Stepping motor controller ch.3 output pin
22	P90	F	General-purpose I/O port
	SEG22		LCD controller/driver segment output pin
23	P91	F	General-purpose I/O port
	SEG23		LCD controller/driver segment output pin
31	P94	G	General-purpose I/O port
	V0		LCD controller/driver reference power supply pin
32	P95	G	General-purpose I/O port
	V1		LCD controller/driver reference power supply pin

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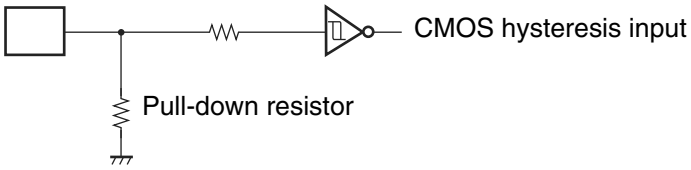
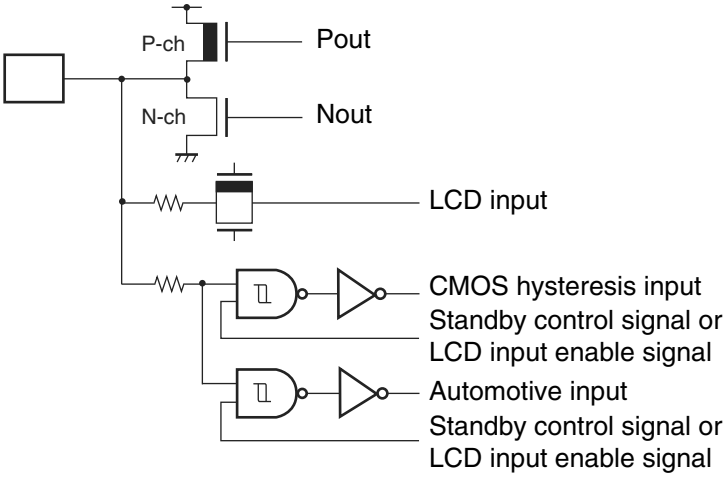
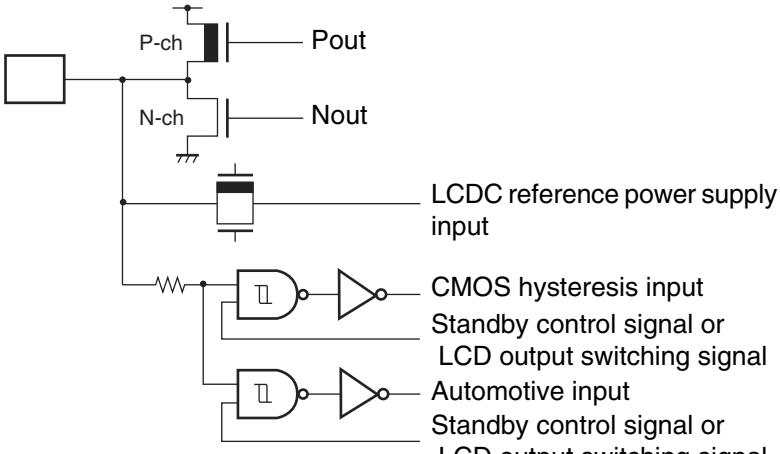
Type	Circuit	Remarks
E		Input-only pin (with pull-down resistance) • Attached pull-down resistance: approx. 50 kΩ • CMOS hysteresis input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.2 V_{CC}) Note: The MD2 pin of the evaluation products uses this circuit type.
F		LCD output common general-purpose port • CMOS output (I_{OH}/I_{OL} = ±4 mA) • Hysteresis input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.2 V_{CC}) • Automotive input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.5 V_{CC})
G		LCDC reference power supply common general-purpose port • CMOS output (I_{OH}/I_{OL} = ±4 mA) • CMOS hysteresis input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.2 V_{CC}) • Automotive input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.5 V_{CC})

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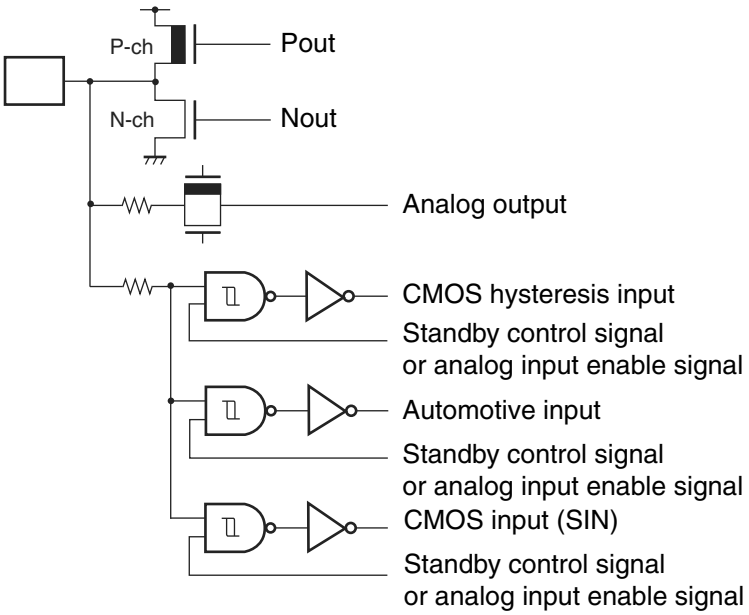
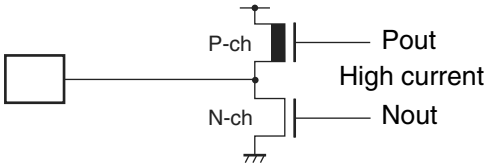
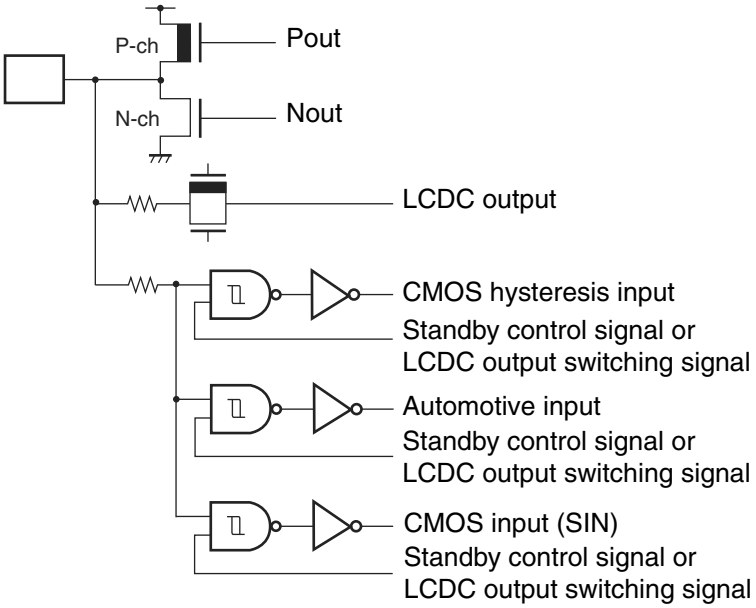
Type	Circuit	Remarks
K		A/D converter input common general-purpose port (serial input) • CMOS output (I_{OH}/I_{OL} = ± 4 mA) • CMOS hysteresis input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.2 V_{CC}) • CMOS input (SIN) (V_{IH}/V_{IL} = 0.7 V_{CC}/0.3 V_{CC}) • Automotive input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.5 V_{CC})
L		High current output port (SMC pin) CMOS output (I_{OH}/I_{OL} = ± 30 mA)
M		LCDC output common general-purpose port (serial input)) • CMOS output (I_{OH}/I_{OL} = ± 4 mA) • CMOS hysteresis input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.2 V_{CC}) • CMOS input (SIN) (V_{IH}/V_{IL} = 0.7 V_{CC}/0.3 V_{CC}) • Automotive input (V_{IH}/V_{IL} = 0.8 V_{CC}/0.5 V_{CC})

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■ HANDLING DEVICES

• Strictly observe maximum rated voltages (preventing latch-up)

In CMOS IC devices, a condition known as latch-up may occur if voltages higher than V_{CC} or lower than V_{SS} are applied to input or output pins other than medium or high withstand voltage pins, or if the voltage applied between VCC and VSS pins exceeds the rated voltage level. If a latch-up occurs, the power supply current may increase dramatically and may destroy semiconductor elements. When using semiconductor devices, always take sufficient care to avoid exceeding maximum ratings.

When the analog system power supply is switched on or off, be careful not to apply the analog power supply (AV_{CC}, AVRH), the analog input voltages and the power supply voltage for the high current output buffer pins (DV_{CC}) in excess of the digital power supply voltage (V_{CC}).

Once the digital power supply voltage (V_{CC}) has been disconnected, the analog power supply (AV_{CC}, AVRH) and the power supply voltage for the high current output buffer pins (DV_{CC}) may be turned on in any sequence.

• Supply voltage stabilization

Rapid fluctuations in the power supply voltage can cause malfunctions even if the Vcc power supply voltage remains within the warranted operating range. It is recommended that the power supply be stabilized such that ripple fluctuations (P-P value) at commercial frequencies (50 Hz/60 Hz) be limited to within 10% of the standard V_{CC} value, and that transient fluctuations due to power supply switching, etc. be limited to a rate of 0.1 V/ms or less.

• Precautions when turning the power on

In order to prevent the built-in step-down circuits from malfunctioning, the time taken for the voltage to rise (0.2 V to 2.7 V) during power-on should be less than 50 μs.

• Handling unused pins

If unused input pins are left open, they may cause malfunctions or latch-up which may lead to permanent damage to the semiconductor. Unused input pins should therefore be pulled up or pulled down through a resistor of at least 2 kΩ.

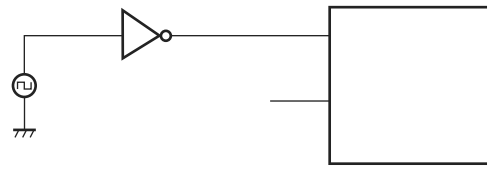
Unused input/output pins may be set to the output state and left open, or set to the input state and connected to a pull-up or pull-down resistance of 2 kΩ or more.

• Handling A/D converter power supply pins

Even if the A/D converter is not used, the power supply pins should be connected such as $AV_{CC} = V_{CC}$, and $AV_{SS} = AVRH = V_{SS}$.

• Notes on using an external clock

Even when an external clock is used, an oscillation stabilization wait time is required following power-on reset or release from sub clock mode or stop mode. Furthermore, only the X0A pin should be driven when an external clock is used, with the X1A pin open as shown in the following diagram. Do not use high-speed oscillation pins (X0 and X1) for external clock input.



Sample external clock connection

- **Serial communication**

In serial communication, reception of wrong data may occur due to noise or other causes. Therefore, design a printed circuit board to prevent noise from occurring. Taking account of the reception of wrong data, detect errors by measures such as adding a checksum to the end of data. If an error is detected, retransmit the data.

- **Characteristic difference between flash device and MASK ROM device**

In the flash device and the MASK ROM device, the electrical characteristic including current consumption, ESD, latch-up, the noise characteristic, and oscillation characteristic, etc. is different according to the difference between the chip layout and the memory structure.

Reconfirm the electrical characteristic when the product is replaced by another product of the same series.

Address	Register name	Symbol	Read/write	Resource name	Initial value
003700H to 0037FFH	Area reserved for CAN Controller 2. Refer to "■ CAN CONTROLLERS"				
003800H to 0038FFH	Area reserved for CAN Controller 3. Refer to "■ CAN CONTROLLERS"				
003900H to 00391FH	(Disabled)				
003920H	PPG0 down counter register	PDCR0	R	16-bit PPG0	11111111B
003921H					11111111B
003922H	PPG0 cycle setting register	PCSR0	W		11111111B
003923H					11111111B
003924H	PPG0 duty setting register	PDUT0	W	16-bit PPG0	00000000B
003925H					00000000B
003926H	PPG0 output division setting register	PPGDIV0	R/W, R		11111100B
003927H	(Disabled)				
003928H	PPG1 down counter register	PDCR1	R	16-bit PPG1	11111111B
003929H					11111111B
00392AH	PPG1 cycle setting register	PCSR1	W		11111111B
00392BH					11111111B
00392CH	PPG1 duty setting register	PDUT1	W		00000000B
00392DH					00000000B
00392EH	PPG1output division setting register	PPGDIV1	R/W, R		11111100B
00392FH	(Disabled)				
003930H	PPG2 down counter register	PDCR2	R	16-bit PPG2	11111111B
003931H					11111111B
003932H	PPG2 cycle setting register	PCSR2	W		11111111B
003933H					11111111B
003934H	PPG2 duty setting register	PDUT2	W		00000000B
003935H					00000000B
003936H	PPG2 output division setting register	PPGDIV2	R/W, R		11111100B
003937H to 00393FH	(Disabled)				
003940H	Input capture register 4	IPCP4	R	Input capture 4/5	XXXXXXXXB
003941H					XXXXXXXXB
003942H	Input capture register 5	IPCP5	R		XXXXXXXXB
003943H					XXXXXXXXB

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■ CAN CONTROLLERS

The CAN controller has the following features :

- Conforms to CAN Specification Version 2.0 Part A and B
  - Supports transmission/reception in standard frame and extended frame formats
- Supports transmission of data frames by receiving remote frames
- 16 transmission/reception message buffers
  - 29-bit ID and 8-byte data
  - Multi-level message buffer configuration
- Provides full-bit comparison, full-bit mask, acceptance register 0/acceptance register 1 for each message buffer as ID acceptance mask
  - 2 acceptance mask registers in either standard frame format or extended frame formats
- Bit rate programmable from 10 kbps to 2 Mbps (when input clock is at 16 MHz)

List of Control Registers(1)

Address				Register	Abbreviation	Access	Initial Value
CAN0	CAN1	CAN2	CAN3				
003C00H	003D00H	003E00H	003F00H	Control status register	CSR	R/W, R	00---000B 0----0-1B
003C01H	003D01H	003E01H	003F01H				
003C02H	003D02H	003E02H	003F02H	Last event indicator register	LEIR	R/W	--------B 000-0000B
003C03H	003D03H	003E03H	003F03H				
003C04H	003D04H	003E04H	003F04H	RX/TX error counter	RTEC	R	00000000B 00000000B
003C05H	003D05H	003E05H	003F05H				
003C06H	003D06H	003E06H	003F06H	Bit timing register	BTR	R/W	-1111111B 11111111B
003C07H	003D07H	003E07H	003F07H				

List of Message Buffers (Data register)

Address				Register	Abbre-viation	Access	Initial Value
CAN0	CAN1	CAN2	CAN3				
003A80H to 003A87H	003B80H to 003B87H	003780H to 003787H	003880H to 003887H	Data register 0 (8 bytes)	DTR0	R/W	XXXXXXXXB to XXXXXXXXB
003A88H to 003A8FH	003B88H to 003B8FH	003788H to 00378FH	003888H to 00388FH	Data register 1 (8 bytes)	DTR1	R/W	XXXXXXXXB to XXXXXXXXB
003A90H to 003A97H	003B90H to 003B97H	003790H to 003797H	003890H to 003897H	Data register 2 (8 bytes)	DTR2	R/W	XXXXXXXXB to XXXXXXXXB
003A98H to 003A9FH	003B98H to 003B9FH	003798H to 00379FH	003898H to 00389FH	Data register 3 (8 bytes)	DTR3	R/W	XXXXXXXXB to XXXXXXXXB
003AA0H to 003AA7H	003BA0H to 003BA7H	0037A0H to 0037A7H	0038A0H to 0038A7H	Data register 4 (8 bytes)	DTR4	R/W	XXXXXXXXB to XXXXXXXXB
003AA8H to 003AAFH	003BA8H to 003BAFH	0037A8H to 0037AFH	0038A8H to 0038AFH	Data register 5 (8 bytes)	DTR5	R/W	XXXXXXXXB to XXXXXXXXB
003AB0H to 003AB7H	003BB0H to 003BB7H	0037B0H to 0037B7H	0038B0H to 0038B7H	Data register 6 (8 bytes)	DTR6	R/W	XXXXXXXXB to XXXXXXXXB
003AB8H to 003ABFH	003BB8H to 003BBFH	0037B8H to 0037BFH	0038B8H to 0038BFH	Data register 7 (8 bytes)	DTR7	R/W	XXXXXXXXB to XXXXXXXXB
003AC0H to 003AC7H	003BC0H to 003BC7H	0037C0H to 0037C7H	0038C0H to 0038C7H	Data register 8 (8 bytes)	DTR8	R/W	XXXXXXXXB to XXXXXXXXB
003AC8H to 003ACFH	003BC8H to 003BCFH	0037C8H to 0037CFH	0038C8H to 0038CFH	Data register 9 (8 bytes)	DTR9	R/W	XXXXXXXXB to XXXXXXXXB
003AD0H to 003AD7H	003BD0H to 003BD7H	0037D0H to 0037D7H	0038D0H to 0038D7H	Data register 10 (8 bytes)	DTR10	R/W	XXXXXXXXB to XXXXXXXXB
003AD8H to 003ADFH	003BD8H to 003BDFH	0037D8H to 0037DFH	0038D8H to 0038DFH	Data register 11 (8 bytes)	DTR11	R/W	XXXXXXXXB to XXXXXXXXB
003AE0H to 003AE7H	003BE0H to 003BE7H	0037E0H to 0037E7H	0038E0H to 0038E7H	Data register 12 (8 bytes)	DTR12	R/W	XXXXXXXXB to XXXXXXXXB
003AE8H to 003AEFH	003BE8H to 003BEFH	0037E8H to 0037EFH	0038E8H to 0038EFH	Data register 13 (8 bytes)	DTR13	R/W	XXXXXXXXB to XXXXXXXXB
003AF0H to 003AF7H	003BF0H to 003BF7H	0037F0H to 0037F7H	0038F0H to 0038F7H	Data register 14 (8 bytes)	DTR14	R/W	XXXXXXXXB to XXXXXXXXB
003AF8H to 003AFFH	003BF8H to 003BFFH	0037F8H to 0037FFH	0038F8H to 0038FFH	Data register 15 (8 bytes)	DTR15	R/W	XXXXXXXXB to XXXXXXXXB

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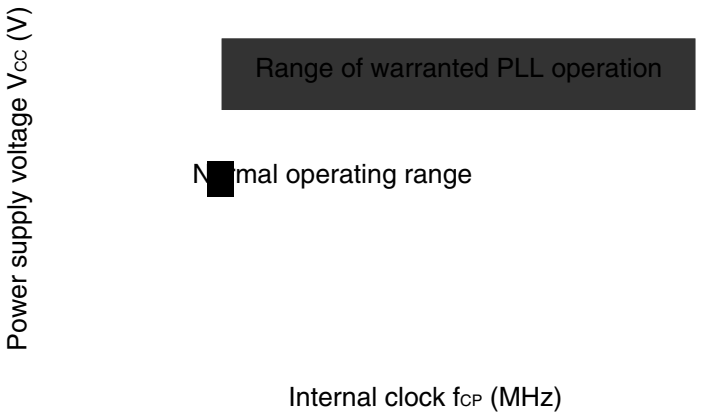
(V_{CC} = 5.0 V ±10%, V_{SS} = DV_{SS} = AV_{SS} = 0.0 V, T_A = − 40 °C to +105 °C)

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
LCDC leakage current	I_{LCDC}	V0 to V3, COMm (m = 0 to 3) , SEGn, (n = 00 to 31)	—	—	—	5.0	µA	
LCD output impedance	Rvcom	COMn (n = 0 to 3)	—	—	—	4.5	kΩ	
	Rvseg	SEGn (n = 00 to 31)	—	—	—	17	kΩ	

* : Power supply current values assume an external clock supplied to the X1 pin and X1A pin. Users must be aware that power supply current levels differ depending on whether an external clock or oscillator is used.

• **Guaranteed PLL Operation Range**

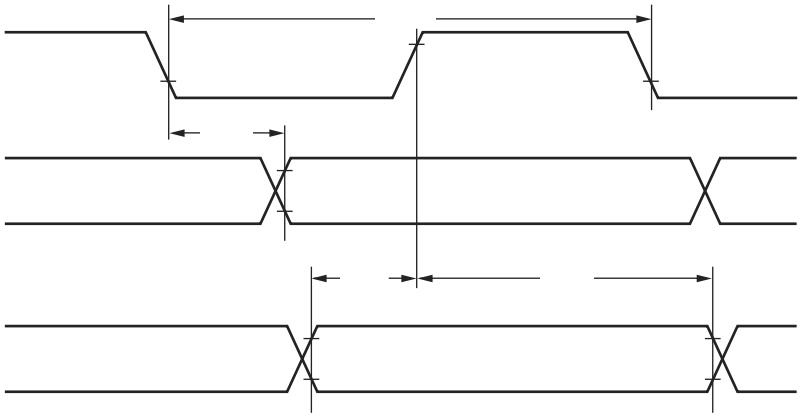
Internal operating clock frequency vs. Power supply voltage



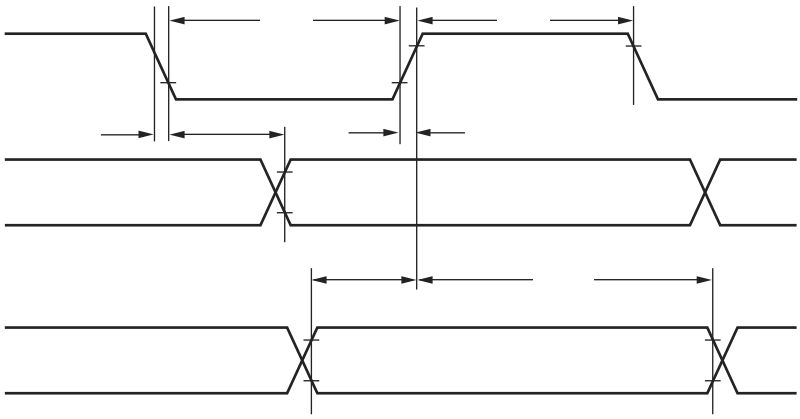
Notes : • For PLL 1 × only, use with tcp = 4 MHz or greater.
• Refer to “5. A/D Converter (1) Electrical Characteristics” for details on the A/D converter operating frequency.

(Continued)

- Internal shift clock mode



- External shift clock mode



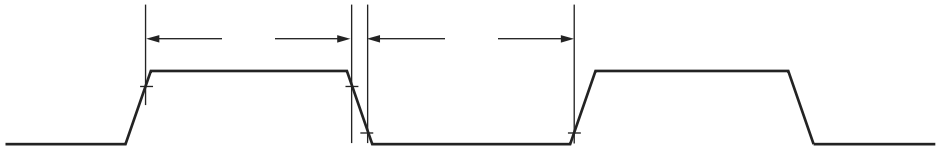
(5) Timer input timing

(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = –40 °C to +105 °C)

Parameter	Symbol	Pin name	Conditions	Value		Unit
				Min	Max	
Input pulse width	t_{TIWH} t_{TIWL}	TIN0, TIN1, IN0 to IN3	—	4 t_{CP}	—	ns

Note : t_{CP} is the internal operating clock cycle time. Refer to " (1) Clock timing".

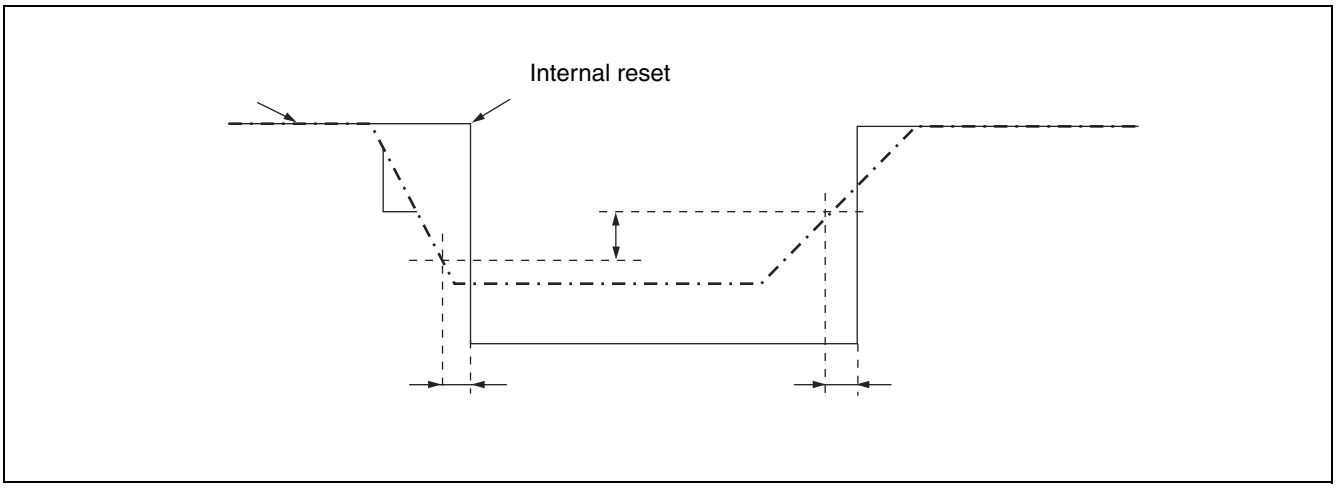
- Timer input timing



(7) Low voltage detection

(V_{SS} = AV_{SS} = 0.0 V, T_A = –40 °C to +105 °C)

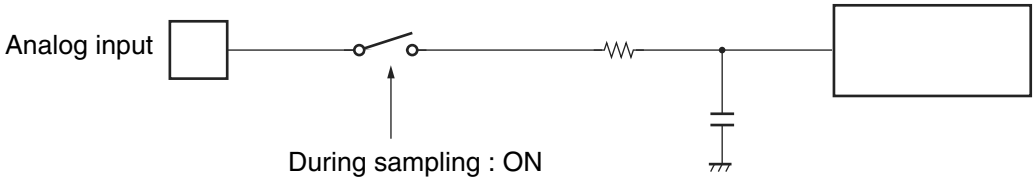
Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Detection voltage	V_{DL}	VCC	—	4.0	4.2	4.4	V	Flash memory product, during voltage drop
				3.7	4.0	4.3	V	Evaluation product, during voltage drop
Hysteresis width	V_{HYS}	VCC	—	190	—	—	mV	Flash memory product, during voltage rise
				0.1	—	—	V	Evaluation product, during voltage rise
Power supply voltage change rate	dV/dt	VCC	—	– 0.1	—	+ 0.1	V/µs	Flash memory product, dV/dt at low voltage reset
				–0.004	—	+ 0.004	V/µs	Flash memory product, dV/dt at standard value of low voltage detection/release voltage
				– 0.1	—	+ 0.02	V/µs	Evaluation product
Detection delay time	td	—	—	—	—	3.2	µs	Flash memory product, when dV/dt ≤ 0.004 V/µs
				—	—	35	µs	Evaluation product



• **Notes on the external impedance and sampling time of analog inputs**

A/D converter with sample and hold circuit. If the external impedance is too high to keep sufficient sampling time, the analog voltage charged to the internal sample and hold capacitor is insufficient, adversely affecting A/D conversion precision. Therefore, to satisfy the A/D conversion precision standard, consider the relationship between the external impedance and minimum sampling time and either adjust the register value and operating frequency or decrease the external impedance so that the sampling time is longer than the minimum value. If the sampling time is still not sufficient, connect a capacitor of about 0.1 μF to the analog input pin.

• Analog input equivalent circuit



MB90F922NC/F922NCS/ F923NC/F923NCS/F924NC/F924NCS
MB90922NCS

	R	C
4.5 V ≤ AVcc ≤ 5.5 V :	2.6 kΩ (Max)	8.5 pF (Max)
4.0 V ≤ AVcc ≤ 4.5 V :	12.1 kΩ (Max)	8.5 pF (Max)

MB90V920-101/102

4.5 V ≤ AVcc ≤ 5.5 V :	2.0 kΩ (Max)	14.4 pF (Max)
4.0 V ≤ AVcc ≤ 4.5 V :	8.2 kΩ (Max)	14.4 pF (Max)

Note : The values are reference values.

6. Flash Memory Program/Erase Characteristics

Parameter	Conditions	Value			Unit	Remarks
		Min	Typ	Max		
Sector erase time	T_A = + 25 °C V_{CC} = 5.0 V	—	0.9	3.6	s	Excludes pre-programming before erase
Word (16-bit width) programming time		—	23	370	µs	Excludes system-level overhead
Chip programming time	T_A = + 25 °C, V_{CC} = 5.0 V	—	3.4	55	s	
Erase/program cycle	—	10000	—	—	cycle	
Flash memory data retention time	Average T_A = + 85 °C	20	—	—	year	*

* : This value is calculated from the results of evaluating the reliability of the technology (using Arrhenius equation to translate high temperature measurements into normalized value at + 85 °C) .

■ ORDERING INFORMATION

Part number	Package	Remarks
MB90F922NCPMC MB90F922NCSPMC MB90922NCSPMC MB90F923NCPMC MB90F923NCSPMC MB90F924NCPMC MB90F924NCSPMC	120-pin plastic LQFP (FPT-120P-M21)	
MB90V920-101CR MB90V920-102CR	299-pin ceramic PGA (PGA-299C-A01)	For evaluation

MEMO